

### VM090S (old ref.: VWA 0001127 AA)

## • General Description

The VM090S is a packaged power amplifier matched through 50Ω RF accesses. It can provide an output power up to 18W and associated power added efficiency of 29% in pulsed mode.

The VM090S is offered a hermetically sealed 10 leads 8 x 8 QFN designed to a surface mount design board. The QFN has a CuW base for superior thermal management. The VM090S integrates the VM090D VectraWave HPA.

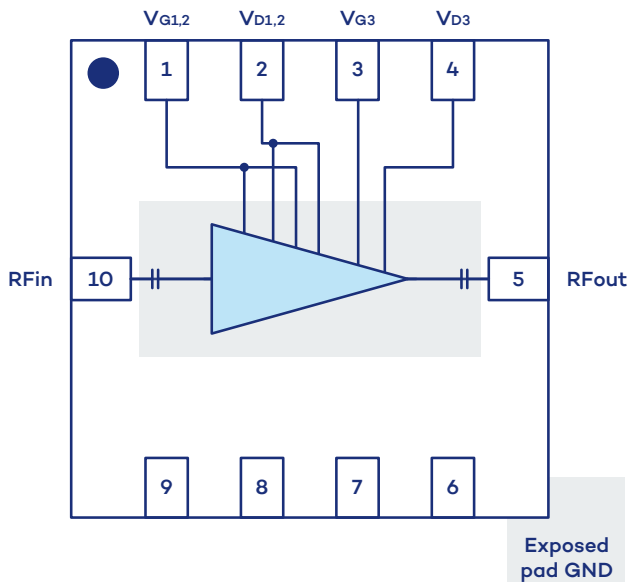
## • Features

Frequency range	<b>8.5 – 10.5GHz</b>
Output Power	<b>42.6dBm @Pin = 23dBm</b>
PAE	<b>29% @Pin = 23dBm</b>
Linear Gain	<b>27dB</b>
DC bias	<b>V<sub>D</sub> = +28V, I<sub>DQ</sub> = 190mA, V<sub>G</sub> = -2.35V (Typical)</b>
Hermetic QFN	<b>8 x 8 (mm) 10leads</b>

## • Applications

- Radar
- Test and Measurement

## • Pins Assignment & Functional Block Diagram



Function	Pin number
V <sub>G1,2</sub>	1
V <sub>D1,2</sub>	2
V <sub>G3</sub>	3
V <sub>D3</sub>	4
RFout	5
NC	6
NC	7
NC	8
NC	9
RFin	10

## • Electrical Specifications

Test conditions: unless otherwise noted

- $T_{amb} = +25^{\circ}\text{C}$
- $V_D = +28\text{V}$
- $I_{DQ} = 190\text{mA}$  ( $V_G = -2.35\text{V Typ.}$ )
- Pulsed mode (pulse width:  $30\mu\text{s}$ , duty cycle: 10%)

Symbol	Parameter	Min	Typ	Max	Unit
F	Frequency range	8.5		10.5	GHz
G	Linear gain		27		dB
S11	Input return loss		-10		dB
S22	Output return loss		-12		dB
P <sub>out</sub>	Output power (@P <sub>in</sub> =23dBm)		42.6		dBm
PAE	Associated Power Added Efficiency (@P <sub>in</sub> =23dBm)		29		%
I <sub>D</sub>	Associated Drain current (@P <sub>in</sub> =23dBm)		2.4		A
V <sub>D</sub>	Drain voltage		28		V

## • Recommended Operating Conditions

Symbol	Parameter	Value	Unit
V <sub>D</sub>	Drain voltage	28	V
I <sub>DQ</sub>	Drain quiescent current	190	mA
V <sub>G</sub>	Gate voltage	-2.35 (Typ.)	V

## • Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V <sub>D</sub>	Drain bias voltage	35	V
I <sub>D</sub>	Drain bias current	3	A
V <sub>G</sub>	Gate bias voltage	-10 to -2	V
P <sub>in</sub>	Maximum peak input power overdrive	30	dBm
T <sub>j</sub>	Junction temperature	225	°C
T <sub>a</sub>	Operating temperature range	-40/+85	°C
T <sub>stg</sub>	Storage temperature range	-55/+150	°C

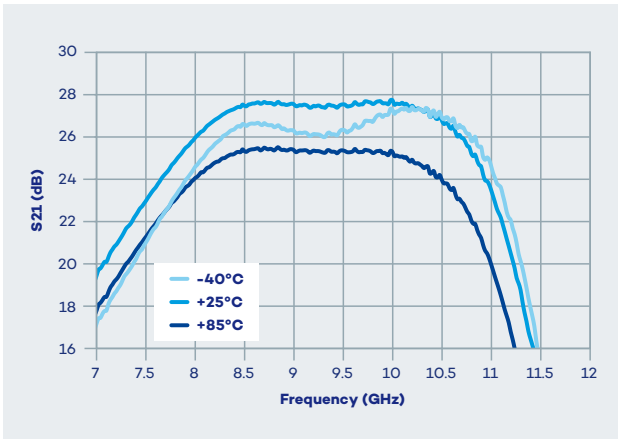
Operation of this device above any of these parameters may cause permanent damage.

• **Typical Performance**  
(Small signal / Board Measurement)

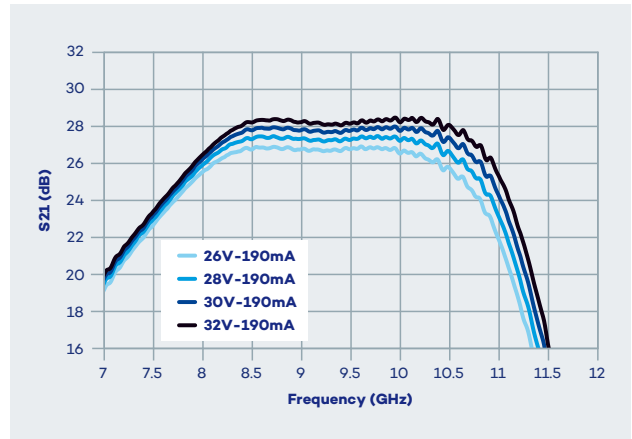
Test conditions: unless otherwise specified

- Reference plane: connector access
- $V_D = +28V$
- $I_{BQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $P_{in} = -20dBm$

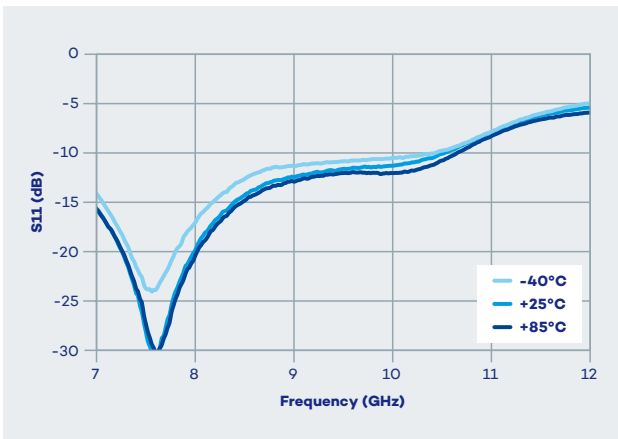
**Gain vs Frequency vs Temperature**



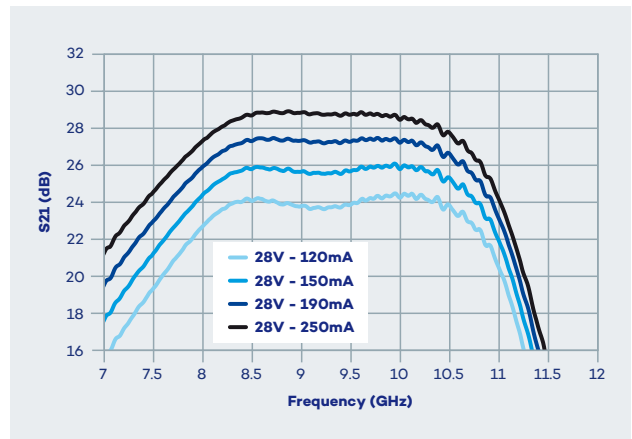
**Gain vs Frequency vs  $V_D$**



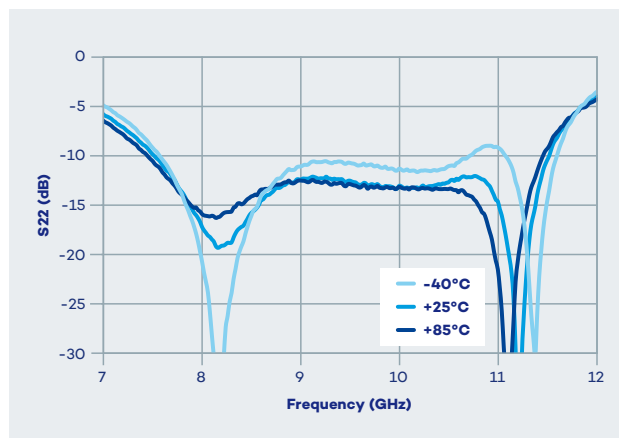
**Input Return Loss vs Frequency vs Temperature**



**Gain vs Frequency vs  $I_{BQ}$**



**Output Return Loss vs Frequency vs Temperature**

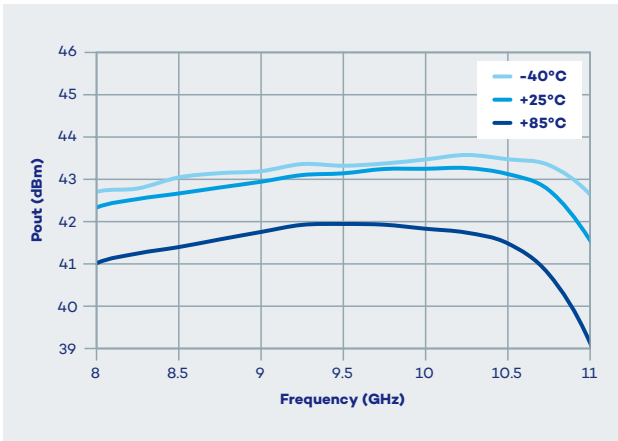


• **Typical Performance**  
(Large signal / Board Measurement)

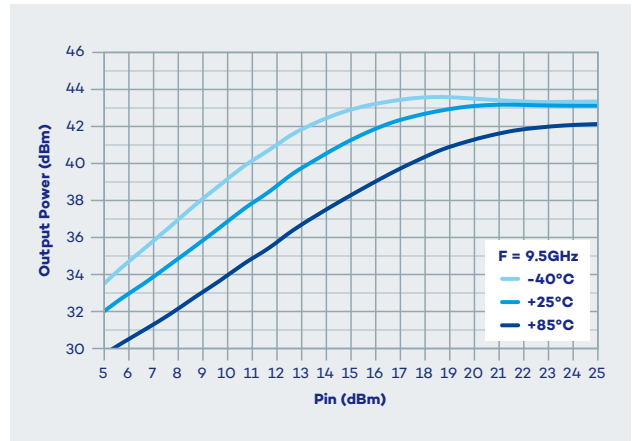
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $I_{BQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $P_{in} = +23dBm$
- Pulsed mode (pulse width:  $30\mu s$ , duty cycle: 10%)

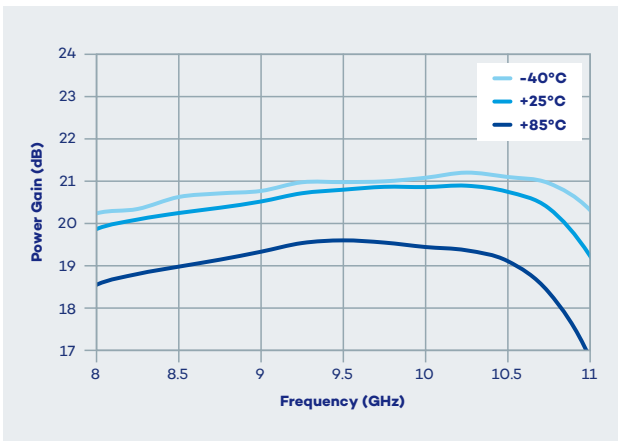
**Output Power vs Frequency vs Temperature**



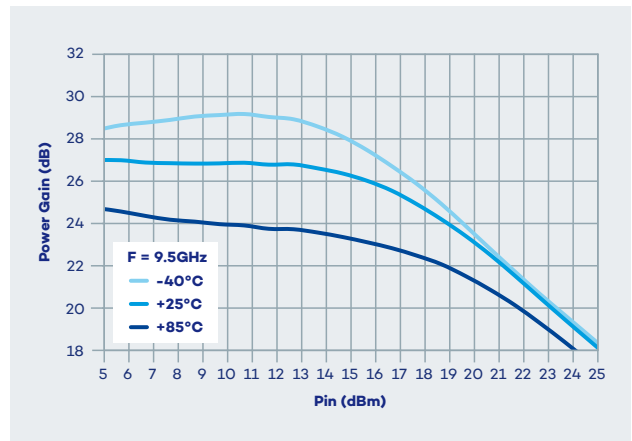
**Output Power vs Input Power vs Temperature**



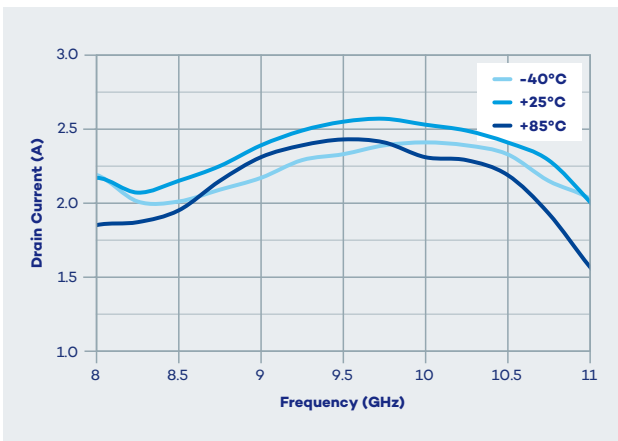
**Power Gain vs Frequency vs Temperature**



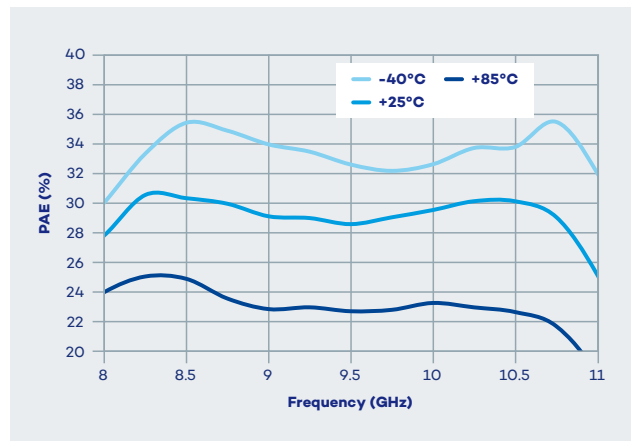
**Gain vs Input Power vs Temperature**



**Drain Current vs Frequency vs Temperature**



**PAE vs Frequency vs Temperature**

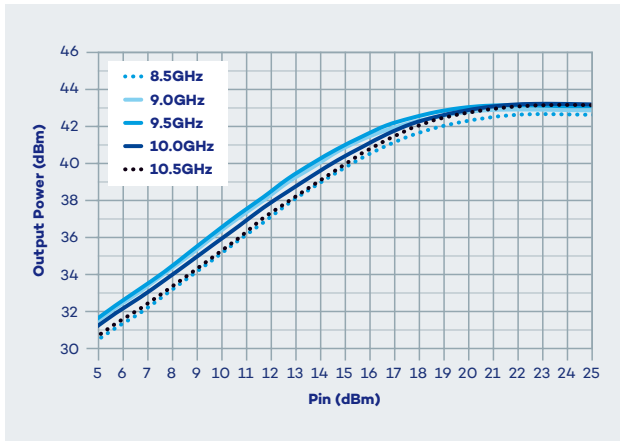


• **Typical Performance**  
(Large signal / Board Measurement)

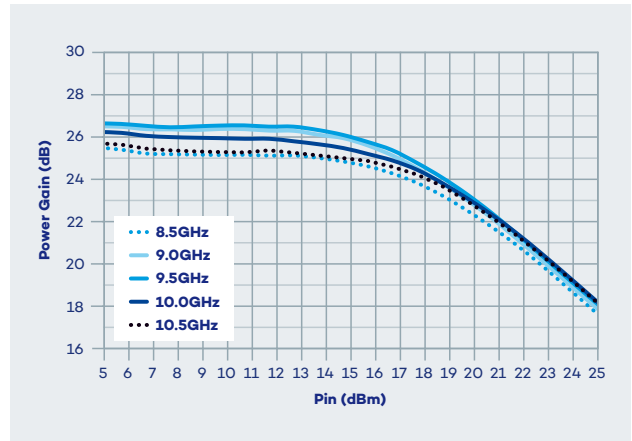
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $I_{DQ} = 190mA$  ( $V_G = -2.35V$  Typ.)
- $T_{amb} = +25^\circ C$
- Pulsed mode (pulse width:  $30\mu s$ , duty cycle: 10%)

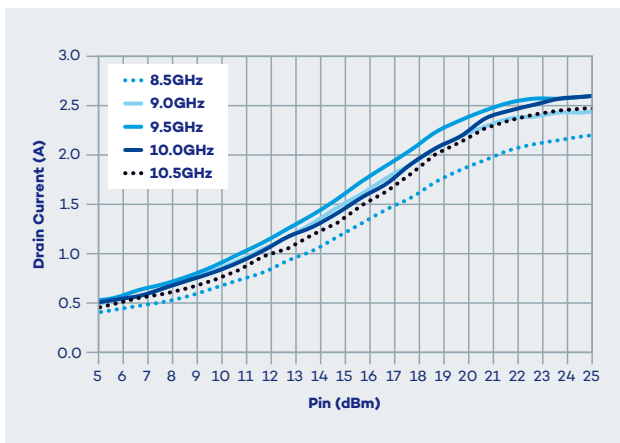
**Output Power vs Input Power vs Frequency**



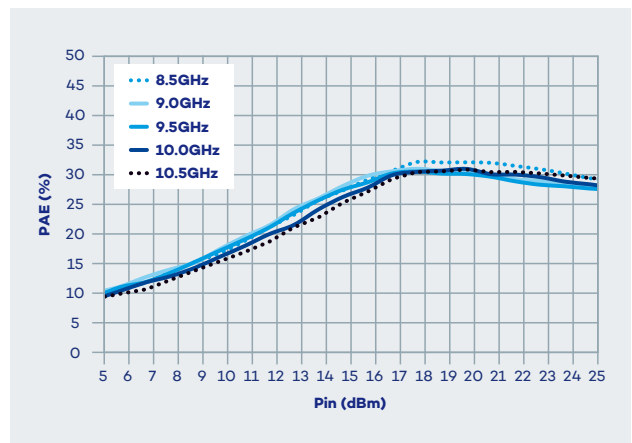
**Gain vs Input Power vs Frequency**



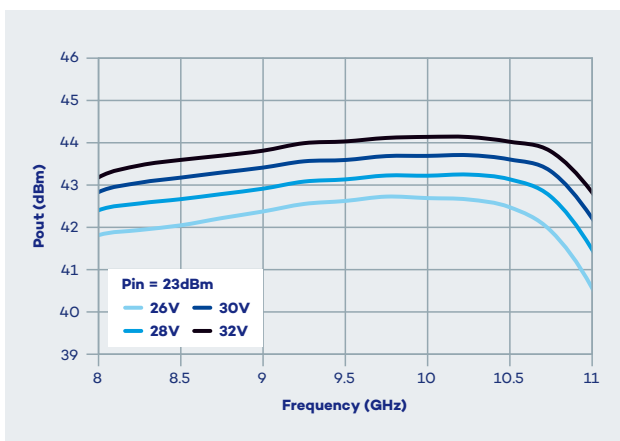
**Drain Current vs Input Power vs Frequency**



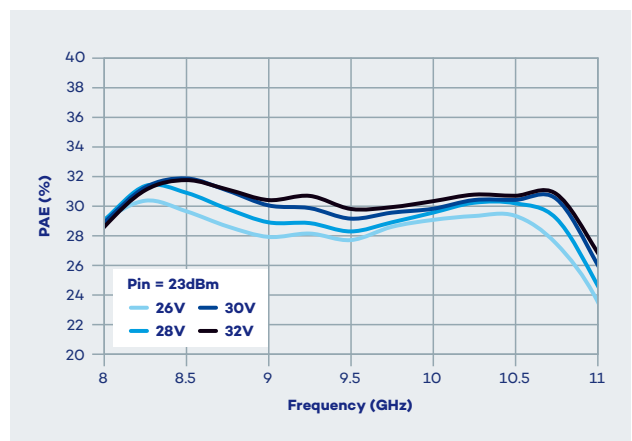
**PAE vs Input Power vs Frequency**



**Output Power vs Frequency vs  $V_D$**



**PAE vs Frequency vs  $V_D$**

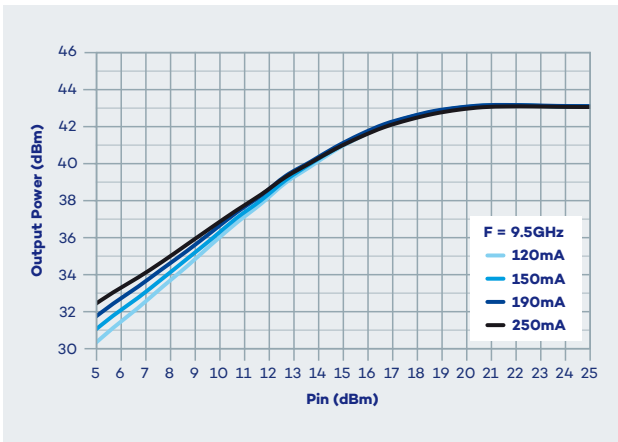


• **Typical Performance**  
(Large signal / Board Measurement)

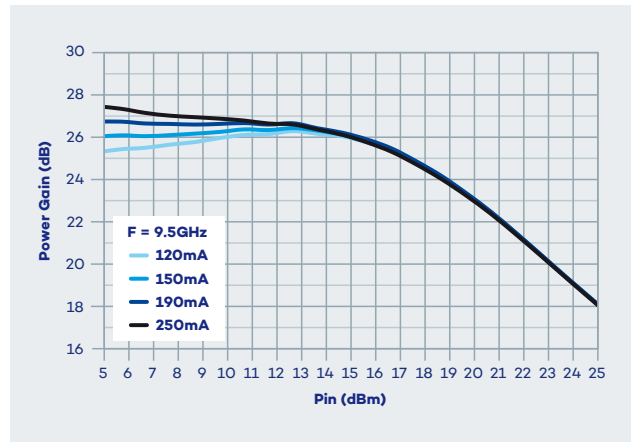
Test conditions: unless otherwise specified

- Reference plane: component access
- $V_D = +28V$
- $T_{amb} = +25^\circ C$
- Pulsed mode (pulse width: 30 $\mu s$ , duty cycle: 10%)

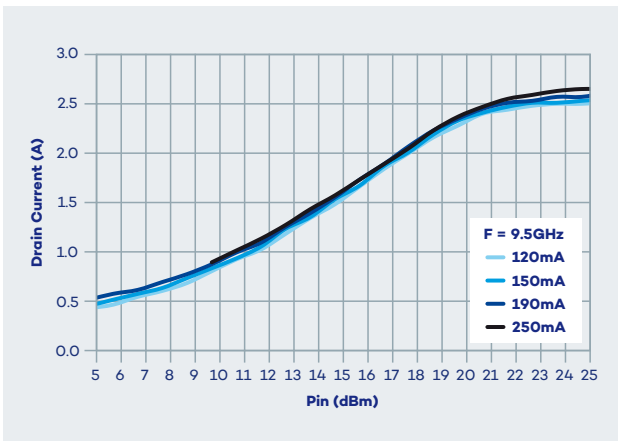
**Output Power vs Input Power vs  $I_{DQ}$**



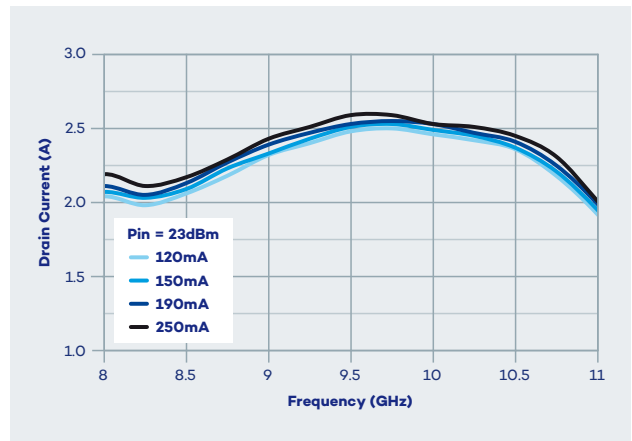
**Gain vs Input Power vs  $I_{DQ}$**



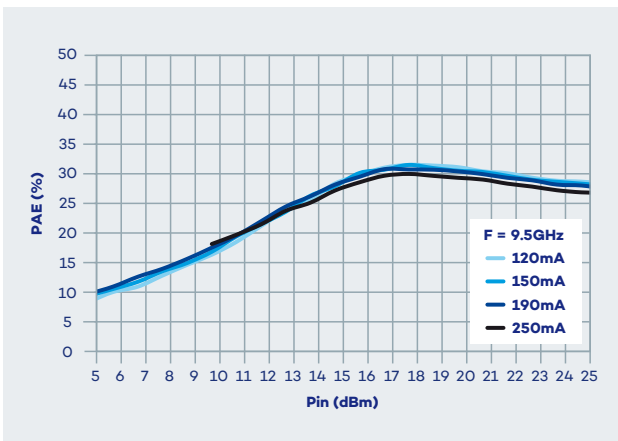
**Drain Current vs Input Power vs  $I_{DQ}$**



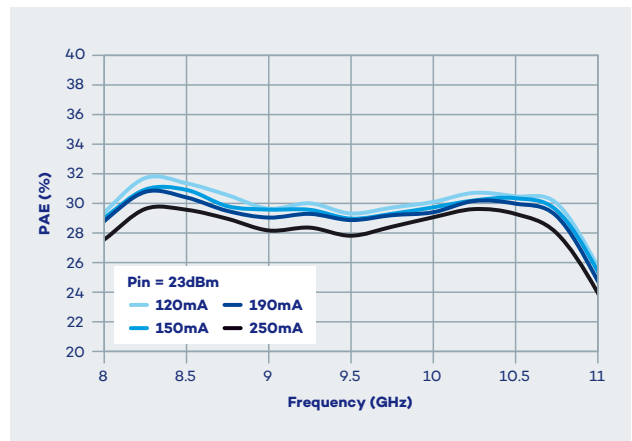
**Drain Current vs Frequency vs  $I_{DQ}$**



**PAE vs Input Power vs  $I_{DQ}$**

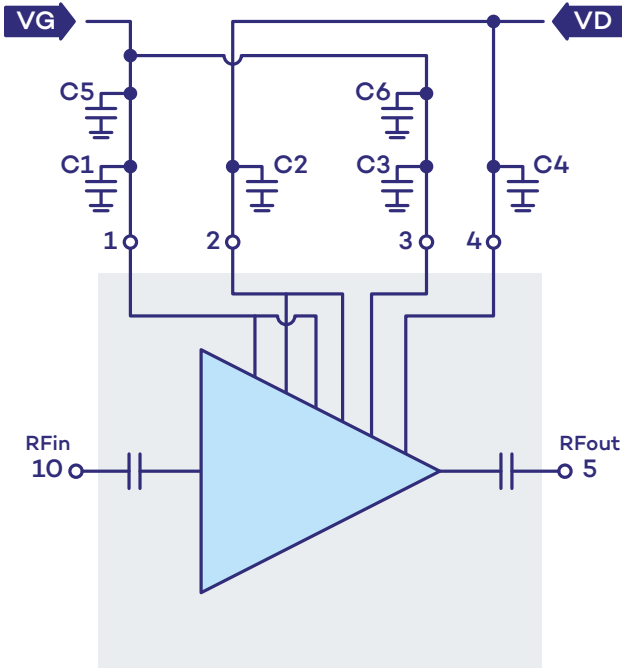


**PAE vs Frequency vs  $I_{DQ}$**



• **Application circuit**

- C1 to C4 = 1μF (50V/0603)
- C5, C6 = 100μF (16V/0805)



• **Bias-up procedure**

1. Apply  $V_G = -3V$
2. Apply  $V_D = +28V$
3. Adjust  $V_G$  to obtain the specified  $I_{BQ} = 190\text{ mA}$  ( $V_G = -2.35V$  Typ.)
4. Apply RF signal in pulsed mode

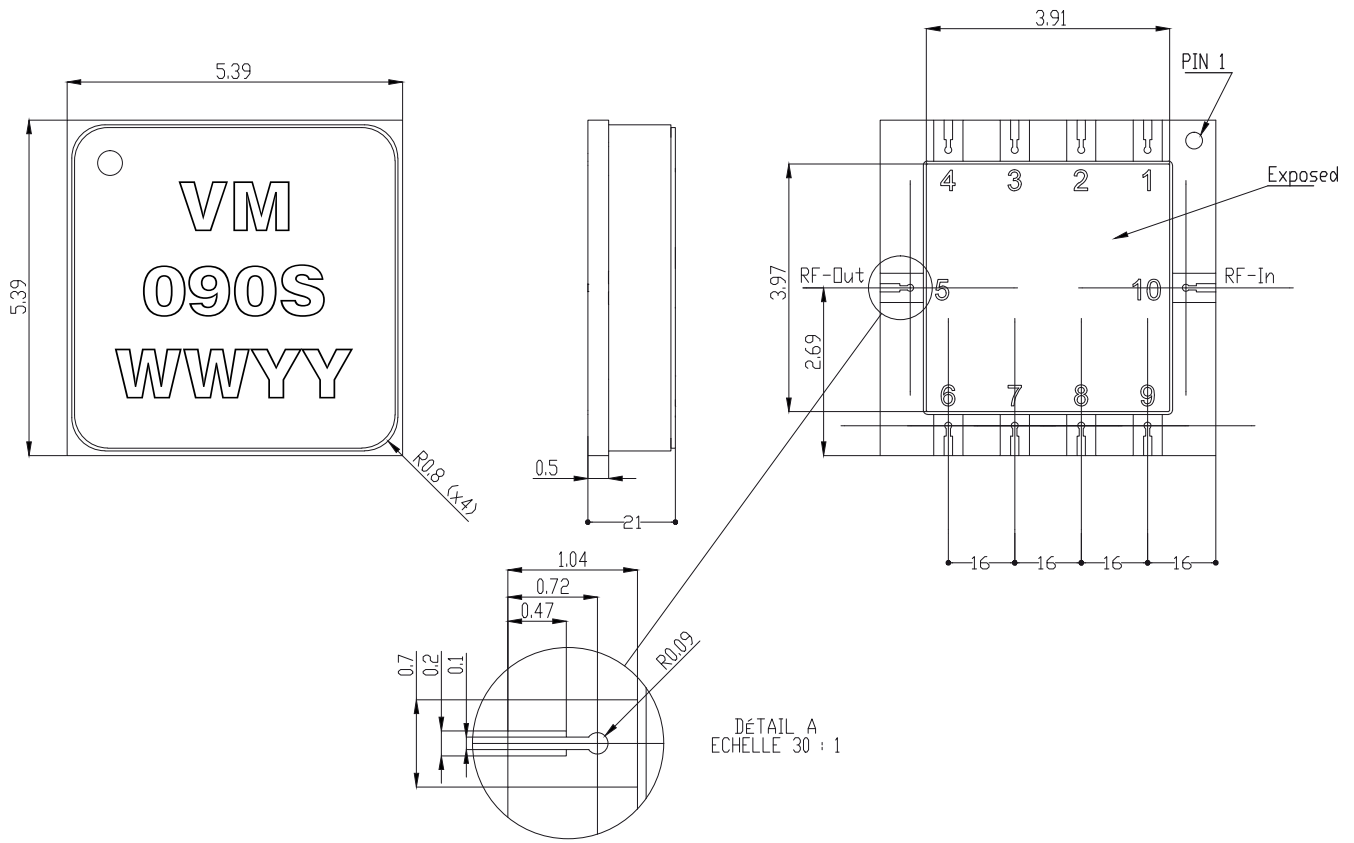
• **Bias-down procedure**

1. Turn off RF signal
2. Reduce  $V_G = -3V$
3. Apply  $V_D = 0V$
4. Turn off power supply

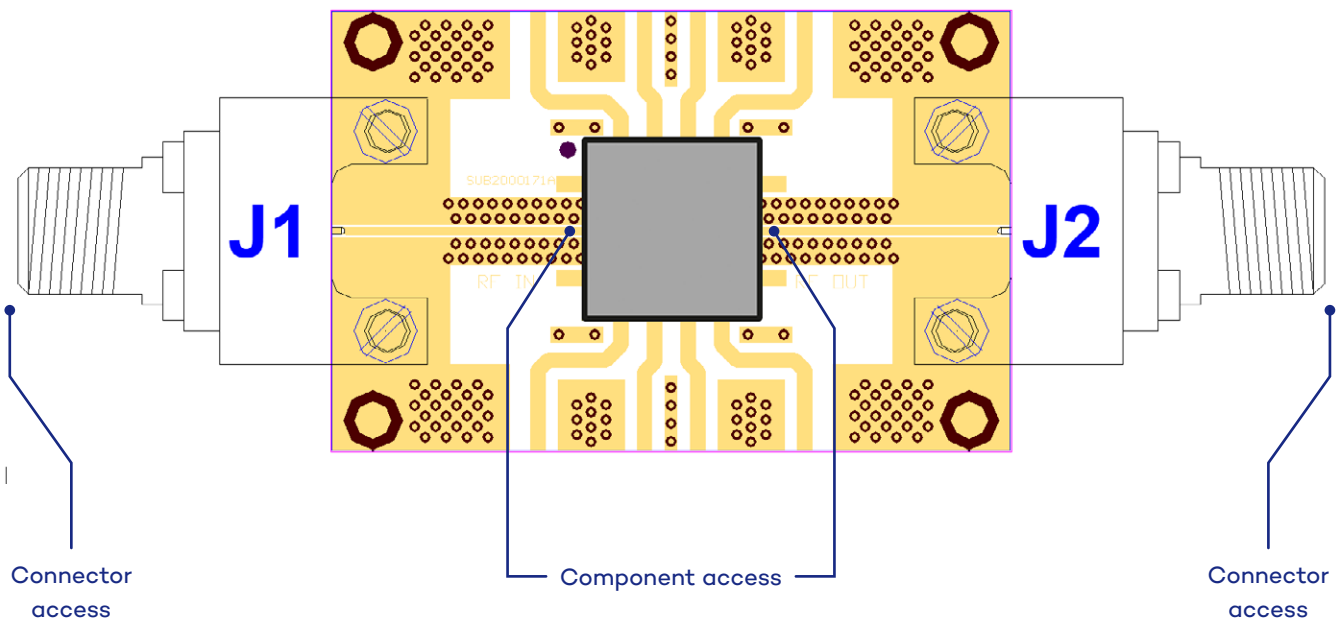
• **Pin description**

Pin number	Name	Description	Electrical interface
10	RF in	Amplifier input, this access is AC coupled and internally matched to 50 Ohms	<p>The schematic shows a GaN power amplifier with an RF input (RF in) and an RF output (RF out). The gate biasing input (VG1,2) is connected to the gate of the amplifier, and the drain biasing input (VD3) is connected to the drain. Ground connections (Gnd) are shown at the source and gate.</p>
1, 3	$V_{G1,2}, V_{G3}$	HPA Gate biasing input accesses	
2, 4	$V_{D1,2}, V_{D3}$	HPA Drain biasing input accesses	
5	RF out	Amplifier output, this access is AC coupled and internally matched to 50 Ohms	
Exposed Pad	Gnd	Die must be connected to RF and DC Ground	<p>A ground symbol consisting of a vertical line with three horizontal bars of decreasing width at the bottom.</p>

• **Mechanical drawing**



• **Evaluation Board (EVB) Layout Assembly**





• **Ordering information**

Product Code	Parameter
VM090S	8.5 to 10.5GHz - 18W GaN Power Amplifier Hermetic QFN 8 x 8 (mm) 10leads

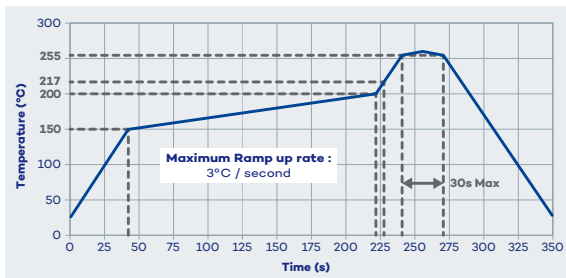
• **Associated Material**

- Evaluation Board
- Mechanical files (DXF)

• **Product Compliance Information**

**Solderability**

Solder Stencil thickness: 127µm  
Solder: SAC 305 (ROHS)  
Temperature profile example: maximum recommended reflow profile (leadfree)



**RoHS-Compliance**

This part is compliant with EU 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

**Other attributes**

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C15H12Br4O2) Free
- PFOS Free
- SVHC Free

**ESD Sensitivity Rating**

Test: Human Body Model (HBM)  
Std: JEDEC Standard JESD22-A114



• **Contact information**

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about Vectrawave.

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